

# MC33076

## Dual High Output Current, Low Power, Low Noise Bipolar Operational Amplifier

The MC33076 operational amplifier employs bipolar technology with innovative high performance concepts for audio and industrial applications. This device uses high frequency PNP input transistors to improve frequency response. In addition, the amplifier provides high output current drive capability while minimizing the drain current. The all NPN output stage exhibits no deadband crossover distortion, large output voltage swing, excellent phase and gain margins, low open loop high frequency output impedance and symmetrical source and sink AC frequency performance.

The MC33076 is tested over the automotive temperature range and is available in an 8-pin SOIC package (D suffix) and in the standard 8 pin DIP package for high power applications.

- 100  $\Omega$  Output Drive Capability
- Large Output Voltage Swing
- Low Total Harmonic Distortion
- High Gain Bandwidth: 7.4 MHz
- High Slew Rate: 2.6 V/ $\mu$ s
- Dual Supply Operation:  $\pm 2.0$  V to  $\pm 18$  V
- High Output Current:  $I_{SC} = 250$  mA typ
- Similar Performance to MC33178

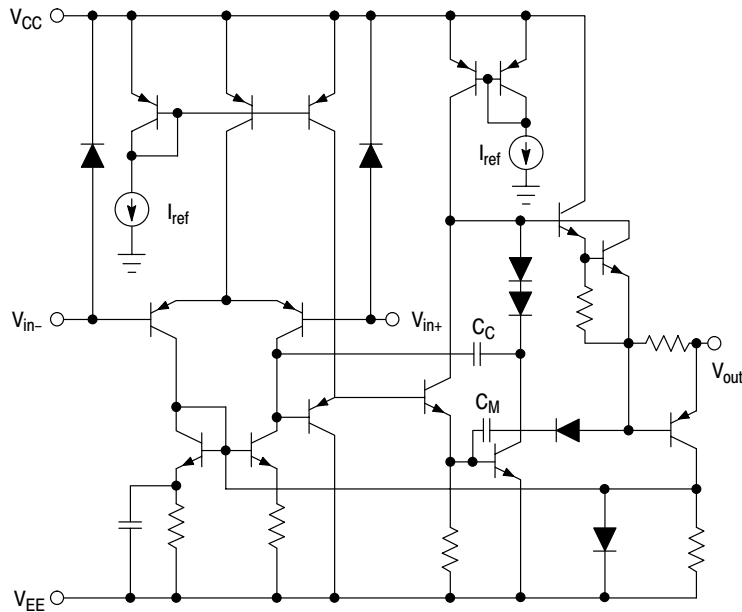


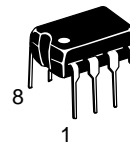
Figure 1. Equivalent Circuit Schematic (Each Amplifier)



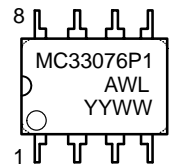
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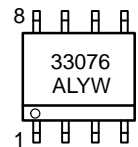
### MARKING DIAGRAMS



PDIP-8  
P1 SUFFIX  
CASE 626

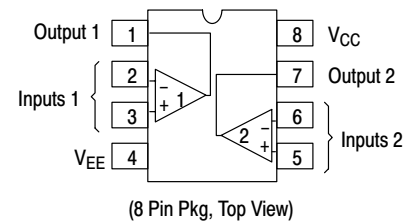


SO-8  
D SUFFIX  
CASE 751



A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week

### PIN CONNECTIONS



### ORDERING INFORMATION

Device	Package	Shipping
MC33076D	SO-8	98 Units/Rail
MC33076DR2	SO-8	2500 Tape & Reel
MC33076P1	PDIP-8	50 Units/Rail

# MC33076

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Supply Voltage (Note 2.)	$V_{CC}$ to $V_{EE}$	+36	V
Input Differential Voltage Range	$V_{IDR}$	Note 1.	V
Input Voltage Range	$V_{IR}$	Note 1.	V
Output Short Circuit Duration (Note 2.)	$t_{SC}$	5.0	sec
Maximum Junction Temperature	$T_J$	+150	°C
Storage Temperature	$T_{stg}$	-60 to +150	°C
Maximum Power Dissipation	$P_D$	Note 2.	mW

1. Either or both input voltages should not exceed  $V_{CC}$  or  $V_{EE}$ .
2. **Power dissipation must be considered to ensure maximum junction temperature ( $T_J$ ) is not exceeded** (see power dissipation performance characteristic, Figure 2). See applications section for further information.

## DC ELECTRICAL CHARACTERISTICS ( $V_{CC} = +15$ V, $V_{EE} = -15$ V, $T_A = 25^\circ\text{C}$ , unless otherwise noted.)

Characteristics	Figure	Symbol	Min	Typ	Max	Unit
Input Offset Voltage ( $R_S = 50 \Omega$ , $V_{CM} = 0$ V) ( $V_S = \pm 2.5$ V to $\pm 15$ V) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+85^\circ\text{C}$	3	$ V_{IO} $	-	0.5 0.5	4.0 5.0	mV
Input Offset Voltage Temperature Coefficient ( $R_S = 50 \Omega$ , $V_{CM} = 0$ V) $T_A = -40^\circ$ to $+85^\circ\text{C}$		$\Delta V_{IO}/\Delta T$	-	2.0	-	$\mu\text{V}/^\circ\text{C}$
Input Bias Current ( $V_{CM} = 0$ V) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+85^\circ\text{C}$	4, 5	$I_{IB}$	-	100	500 600	nA
Input Offset Current ( $V_{CM} = 0$ V) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+85^\circ\text{C}$		$ I_{IO} $	-	5.0	70 100	nA
Common Mode Input Voltage Range	6	$V_{ICR}$	-13	-14 +14	13	V
Large Signal Voltage Gain ( $V_O = -10$ V to $+10$ V) ( $T_A = +25^\circ\text{C}$ ) $R_L = 100 \Omega$ $R_L = 600 \Omega$ ( $T_A = -40^\circ$ to $+85^\circ\text{C}$ ) $R_L = 600 \Omega$	7	$A_{VOL}$	25 50 25	- 200	- -	kV/V
Output Voltage Swing ( $V_{ID} = \pm 1.0$ V) ( $V_{CC} = +15$ V, $V_{EE} = -15$ V) $R_L = 100 \Omega$ $R_L = 100 \Omega$ $R_L = 600 \Omega$ $R_L = 600 \Omega$ ( $V_{CC} = +2.5$ V, $V_{EE} = -2.5$ V) $R_L = 100 \Omega$ $R_L = 100 \Omega$	8, 9, 10	$V_{O+}$ $V_{O-}$ $V_{O+}$ $V_{O-}$ $V_{O+}$ $V_{O-}$	10 - 13 - 1.2 -	+11.7 -11.7 +13.8 -13.8 +1.66 -1.74	- -10 - -13 - -1.2	V
Common Mode Rejection ( $V_{in} = \pm 13$ V)	11	CMR	80	116	-	dB
Power Supply Rejection ( $V_{CC}/V_{EE} = +15$ V/-15 V, +5.0 V/-15 V, +15 V/-5.0 V)	12	PSR	80	120	-	dB

# MC33076

## DC ELECTRICAL CHARACTERISTICS ( $V_{CC} = +15\text{ V}$ , $V_{EE} = -15\text{ V}$ , $T_A = 25^\circ\text{C}$ , unless otherwise noted.)

Characteristics	Figure	Symbol	Min	Typ	Max	Unit
Output Short Circuit Current ( $V_{ID} = \pm 1.0\text{ V}$ Output to Gnd) ( $V_{CC} = +15\text{ V}$ , $V_{EE} = -15\text{ V}$ ) Source Sink ( $V_{CC} = +2.5\text{ V}$ , $V_{EE} = -2.5\text{ V}$ ) Source Sink	13, 14	$I_{SC}$	190 –	+250 –280	– –215	mA
Power Supply Current per Amplifier ( $V_O = 0\text{ V}$ ) ( $V_S = \pm 2.5\text{ V}$ to $\pm 15\text{ V}$ ) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+85^\circ\text{C}$	15	$I_D$	– –	2.2 –	2.8 3.3	mA

## AC ELECTRICAL CHARACTERISTICS ( $V_{CC} = +15\text{ V}$ , $V_{EE} = -15\text{ V}$ , $T_A = 25^\circ\text{C}$ , unless otherwise noted.)

Characteristics	Figure	Symbol	Min	Typ	Max	Unit
Slew Rate ( $V_{in} = -10\text{ V}$ to $+10\text{ V}$ , $R_L = 100\ \Omega$ , $C_L = 100\text{ pF}$ , $A_V = 1.0$ )	16	SR	1.2	2.6	–	V/ $\mu\text{s}$
Gain Bandwidth Product ( $f = 20\text{ kHz}$ )	17	GBW	4.0	7.4	–	MHz
Unity Gain Bandwidth (Open Loop) ( $R_L = 600\ \Omega$ , $C_L = 0\text{ pF}$ )	–	BW	–	3.5	–	MHz
Gain Margin ( $R_L = 600\ \Omega$ , $C_L = 0\text{ pF}$ )	20, 21	$A_m$	–	15	–	dB
Phase Margin ( $R_L = 600\ \Omega$ , $C_L = 0\text{ pF}$ )	20, 21	$\phi_m$	–	52	–	Deg
Channel Separation ( $f = 100\text{ Hz}$ to $20\text{ kHz}$ )	22	CS	–	–120	–	dB
Power Bandwidth ( $V_O = 20\text{ V}_{pp}$ , $R_L = 600\ \Omega$ , THD $\leq 1\%$ )	–	$BW_p$	–	32	–	kHz
Total Harmonic Distortion ( $R_L = 600\ \Omega$ , $V_O = 2.0\text{ V}_{pp}$ , $A_V = 1.0$ ) $f = 1.0\text{ kHz}$ $f = 10\text{ kHz}$ $f = 20\text{ kHz}$	23	THD	– – –	0.0027 0.011 0.022	– – –	%
Open Loop Output Impedance ( $V_O = 0\text{ V}$ , $f = 2.5\text{ MHz}$ , $A_V = 10$ )	24	$ Z_O $	–	75	–	$\Omega$
Differential Input Resistance ( $V_{CM} = 0\text{ V}$ )	–	$R_{in}$	–	200	–	k $\Omega$
Differential Input Capacitance ( $V_{CM} = 0\text{ V}$ )	–	$C_{in}$	–	10	–	pF
Equivalent Input Noise Voltage ( $R_S = 100\ \Omega$ ) $f = 10\text{ Hz}$ $f = 1.0\text{ kHz}$	25	$e_n$	– –	7.5 5.0	–	nV/ $\sqrt{\text{Hz}}$
Equivalent Input Noise Current $f = 10\text{ Hz}$ $f = 1.0\text{ kHz}$	–	$i_n$	– –	0.33 0.15	–	pA/ $\sqrt{\text{Hz}}$

# MC33076

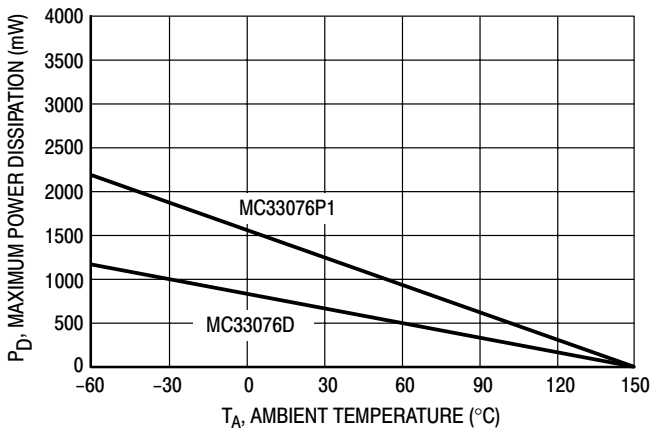


Figure 2. Maximum Power Dissipation versus Temperature

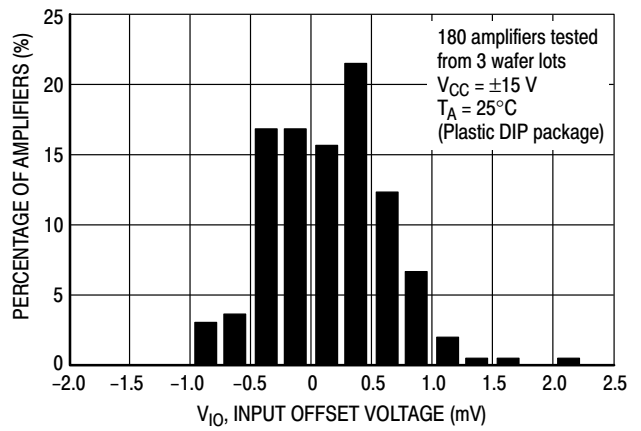


Figure 3. Distribution of Input Offset Voltage

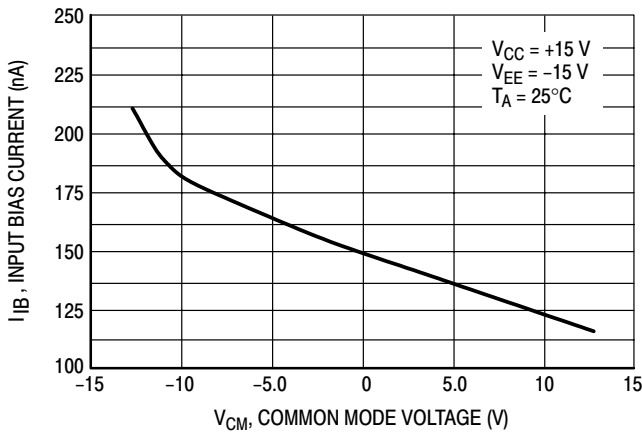


Figure 4. Input Bias Current versus Common Mode Voltage

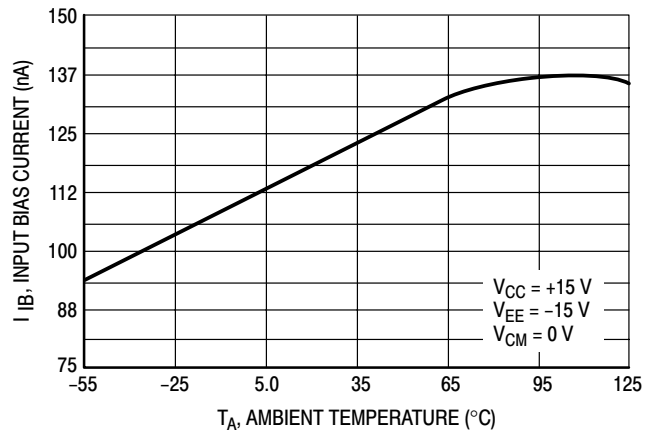


Figure 5. Input Bias Current versus Temperature

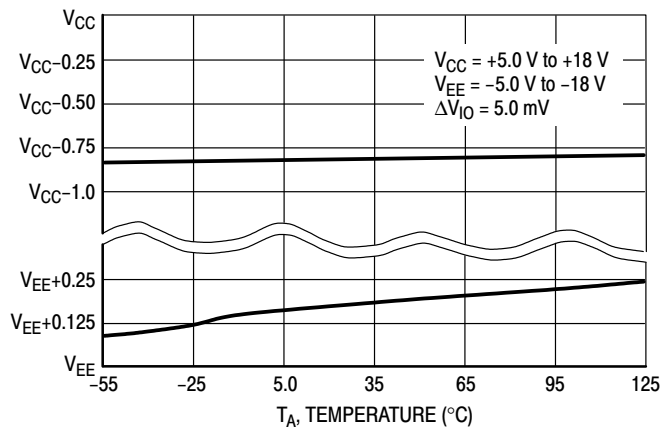


Figure 6. Input Common Mode Voltage Range versus Temperature

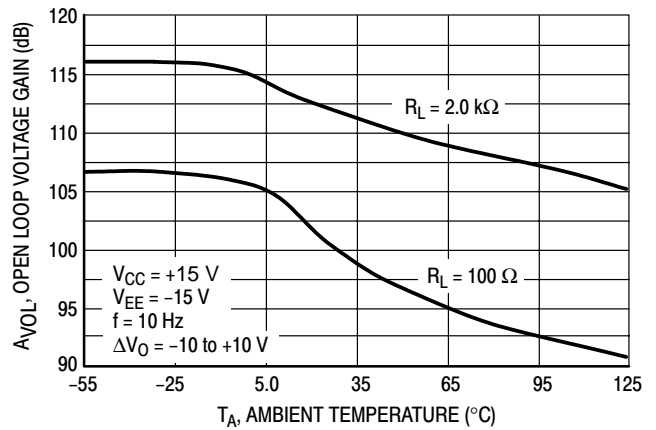


Figure 7. Open Loop Voltage Gain versus Temperature

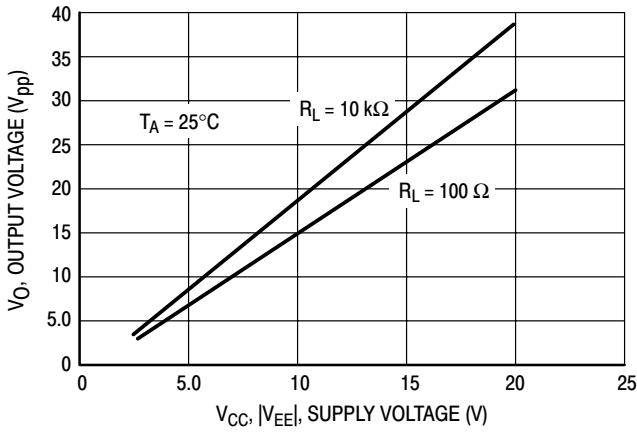


Figure 8. Output Voltage Swing versus Supply Voltage

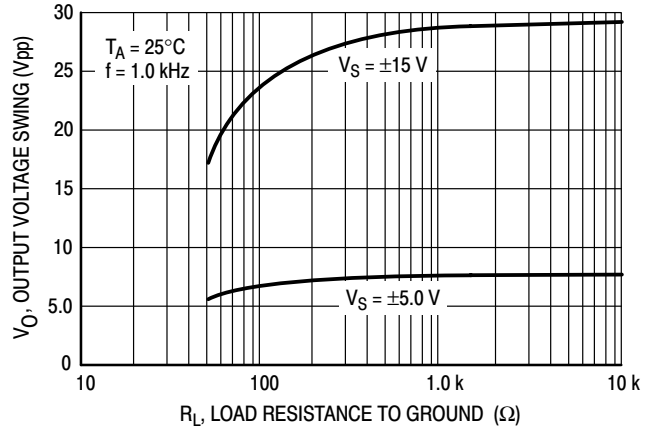


Figure 9. Maximum Peak-to-Peak Output Voltage Swing versus Load Resistance

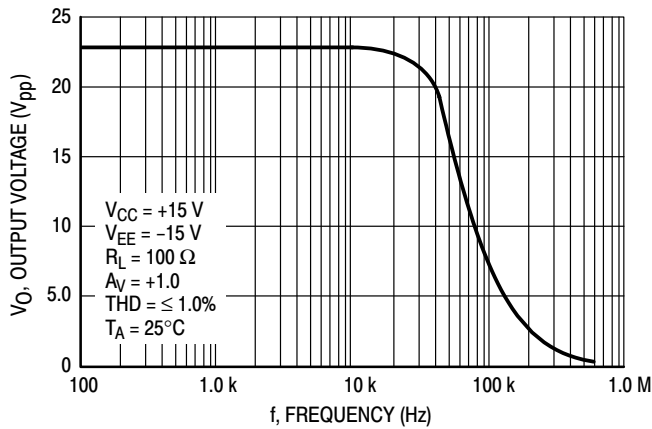


Figure 10. Output Voltage versus Frequency

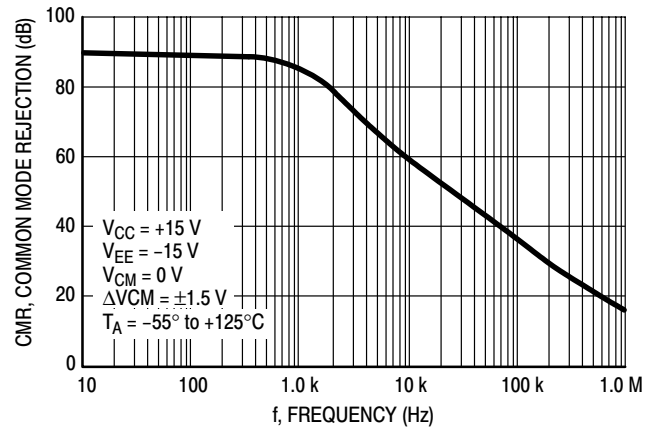


Figure 11. Common Mode Rejection versus Frequency Over Temperature

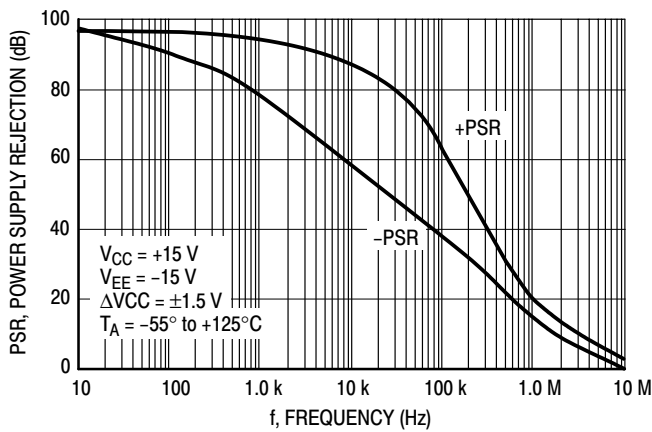


Figure 12. Power Supply Rejection versus Frequency Over Temperature

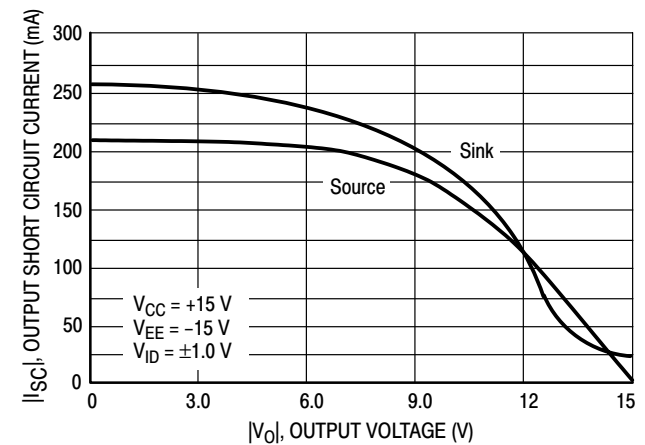


Figure 13. Output Short Circuit Current versus Output Voltage

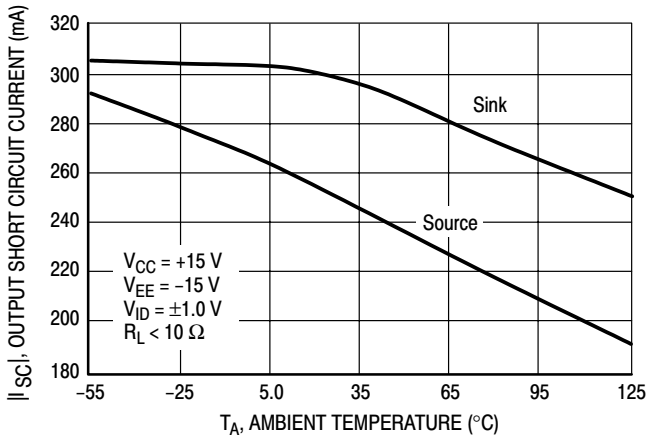


Figure 14. Output Short Circuit Current versus Temperature

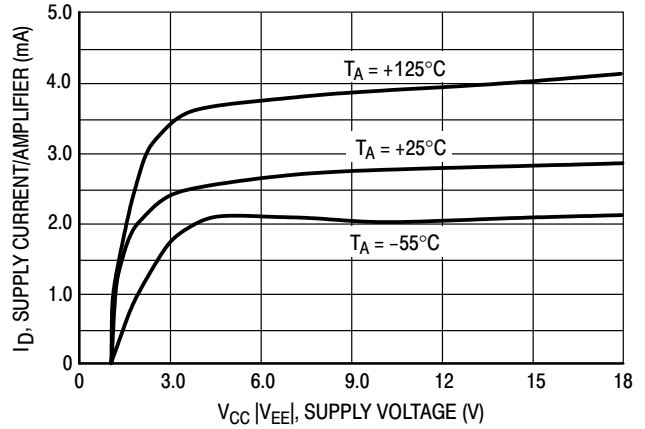


Figure 15. Supply Current versus Supply Voltage with No Load

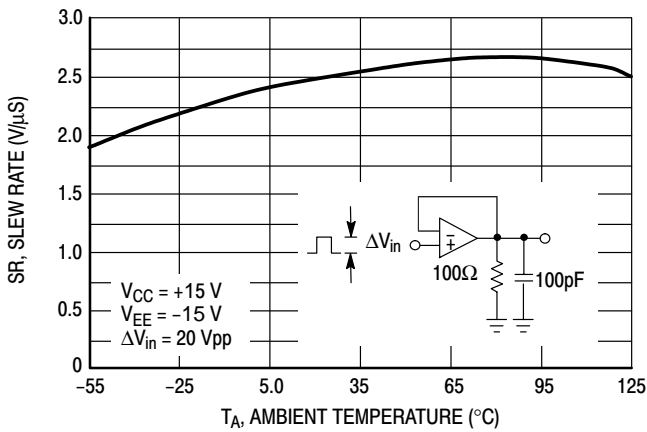


Figure 16. Slew Rate versus Temperature

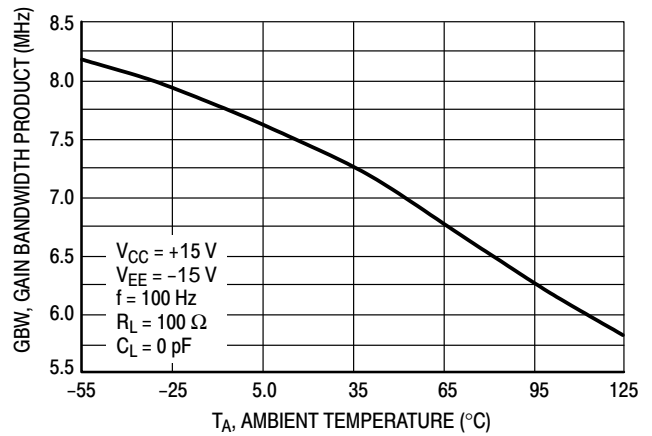


Figure 17. Gain Bandwidth Product versus Temperature

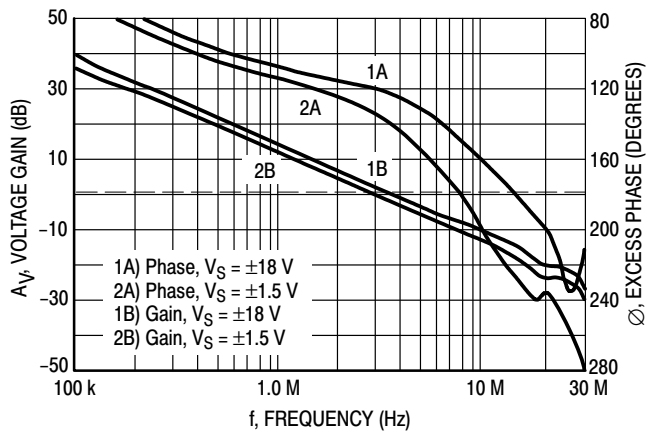


Figure 18. Voltage Gain and Phase versus Frequency

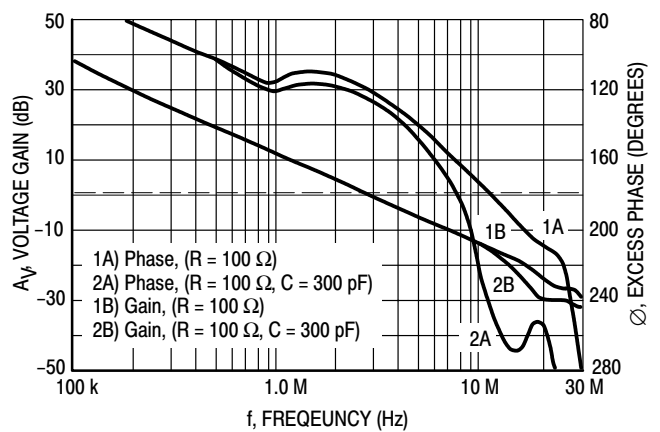


Figure 19. Voltage Gain and Phase versus Frequency

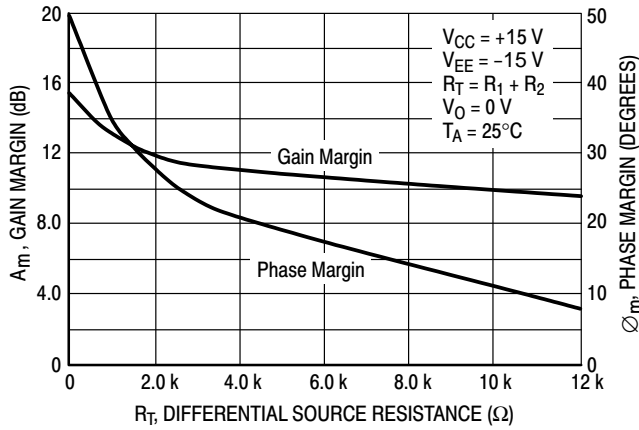


Figure 20. Phase Margin and Gain Margin versus Differential Source Resistance

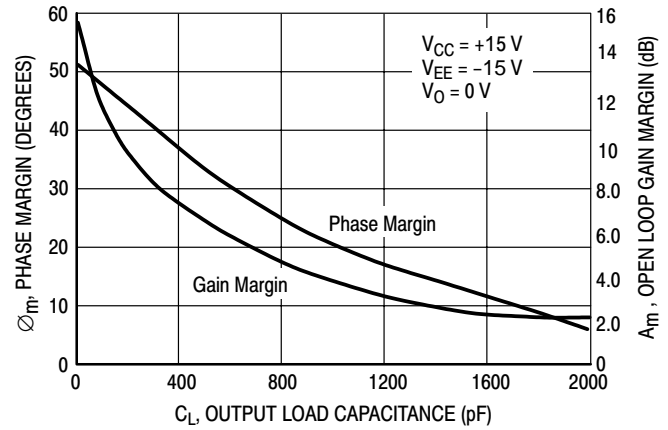


Figure 21. Open Loop Gain Margin and Phase Margin versus Output Load Capacitance

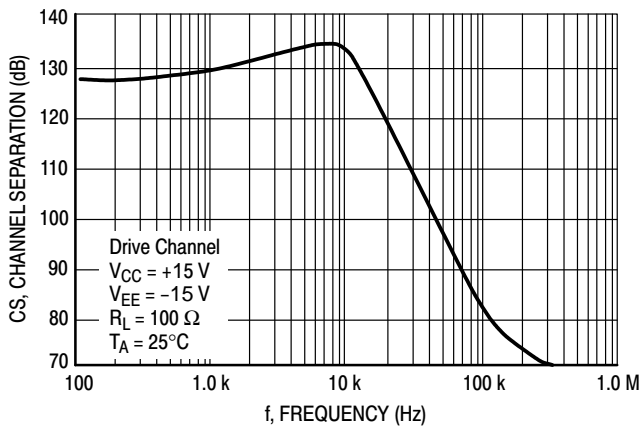


Figure 22. Channel Separation versus Frequency

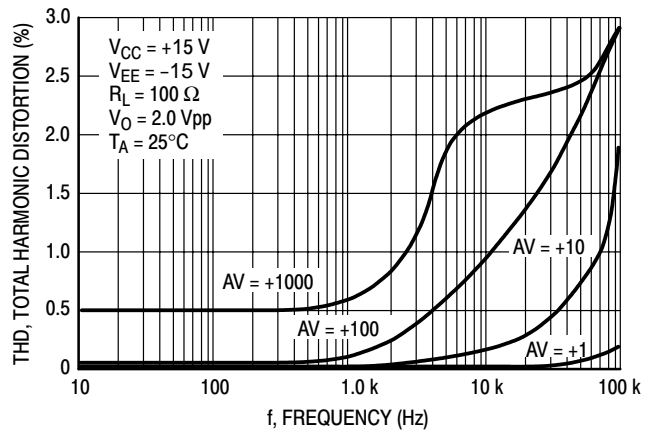


Figure 23. Total Harmonic Distortion versus Frequency

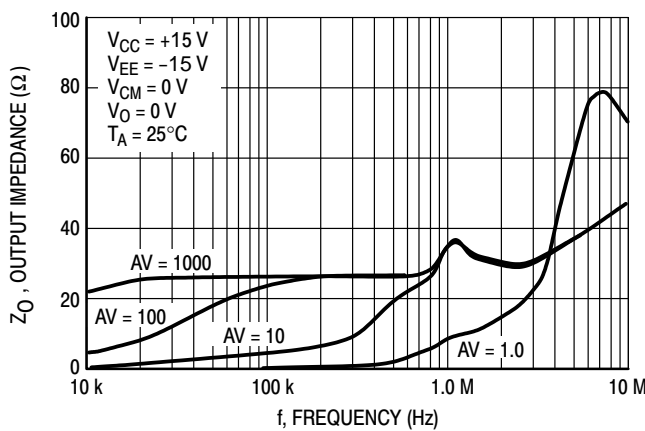


Figure 24. Output Impedance versus Frequency

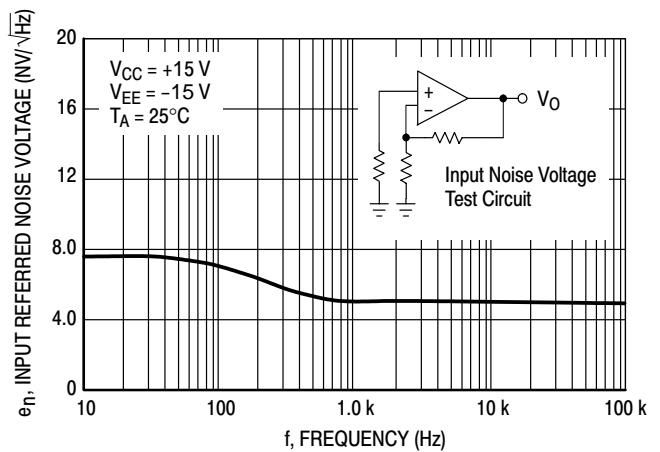


Figure 25. Input Referred Noise Voltage versus Frequency

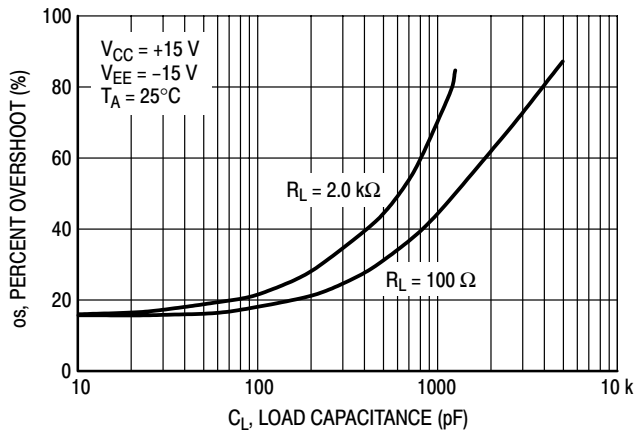


Figure 26. Percent Overshoot versus Load Capacitance

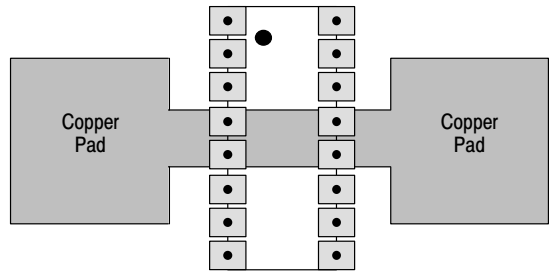


Figure 27. PC Board Heatsink Example

APPLICATIONS INFORMATION

The MC33076 dual operational amplifier is available in the standard 8-pin plastic dual-in-line (DIP) and surface mount packages, and also in a 16-pin batwing power package. To enhance the power dissipation capability of the power package, Pins 4, 5, 12, and 13 are tied together on the leadframe, giving it an ambient thermal resistance of

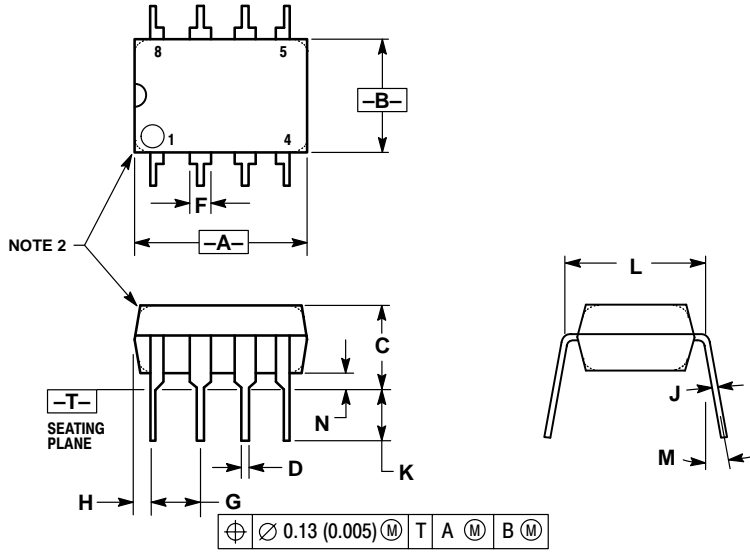
52°C/W typically, in still air. The junction-to-ambient thermal resistance ( $R_{\theta JA}$ ) can be decreased further by using a copper pad on the printed circuit board (as shown in Figure 27) to draw the heat away from the package. *Care must be taken not to exceed the maximum junction temperature or damage to the device may occur.*



# MC33076

## PACKAGE DIMENSIONS

PDIP-8  
P1 SUFFIX  
CASE 626-05  
ISSUE L

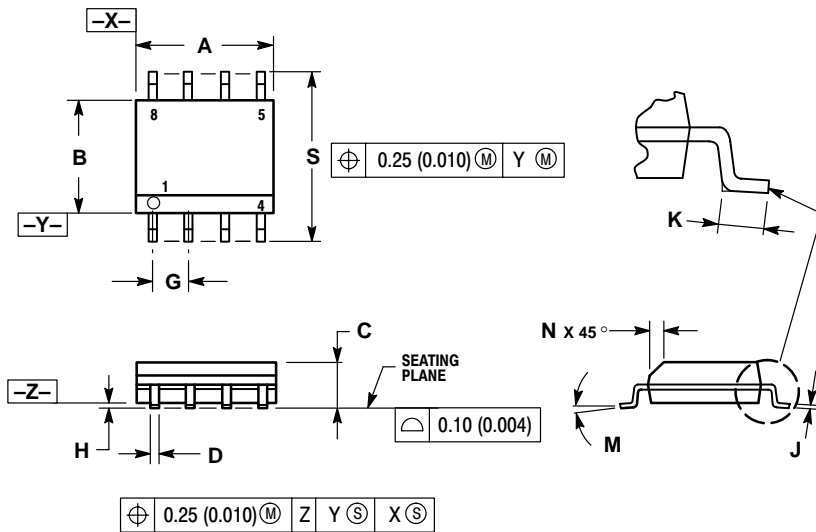


NOTES:

1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	---	10°	---	10°
N	0.76	1.01	0.030	0.040

SO-8  
D SUFFIX  
CASE 751-07  
ISSUE W




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

**Notes**

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